

Features

September 2011

- Internal control latches and address decoder
- Short setup and hold times
- Wide operating voltage: 4.5 V to 13.2 V
- 12 V_{pp} analog signal capability
- R_{ON} 65 Ω max. @ V_{DD} = 12 V, 25°C
- ΔR_{ON} ≤ 10 Ω @ V_{DD} = 12 V, 25C
- Full CMOS switch for low distortion
- Minimum feedthrough and crosstalk
- Low power consumption ISO-CMOS technology
- Internal pull-up resistor for $\overline{\text{RESET}}$ pin

Applications

- Key systems
- PBX systems
- Mobile radio
- Test equipment/instrumentation
- Analog/digital multiplexers
- Audio/Video switching

Ordering Information

| | | |
|------------|--------------|-------------|
| MT8809AP1 | 28 Pin PLCC* | Tubes |
| MT8809APR1 | 28 Pin PLCC* | Tape & Reel |
| MT8809AE1 | 28 Pin PDIP* | Tubes |

* Pb Free Matte Tin

-40°C to +85°C

Description

The Zarlink MT8809 is fabricated in Zarlink's ISO-CMOS technology providing low power dissipation and high reliability. The device contains a 8 x 8 array of crosspoint switches along with a 6 to 64 line decoder and latch circuits. Any one of the 64 switches can be addressed by selecting the appropriate six address bits. The selected switch can be turned on or off by applying a logical one or zero to the DATA input. Chip Select ($\overline{\text{CS}}$) allows the crosspoint array to be cascaded for matrix expansion.

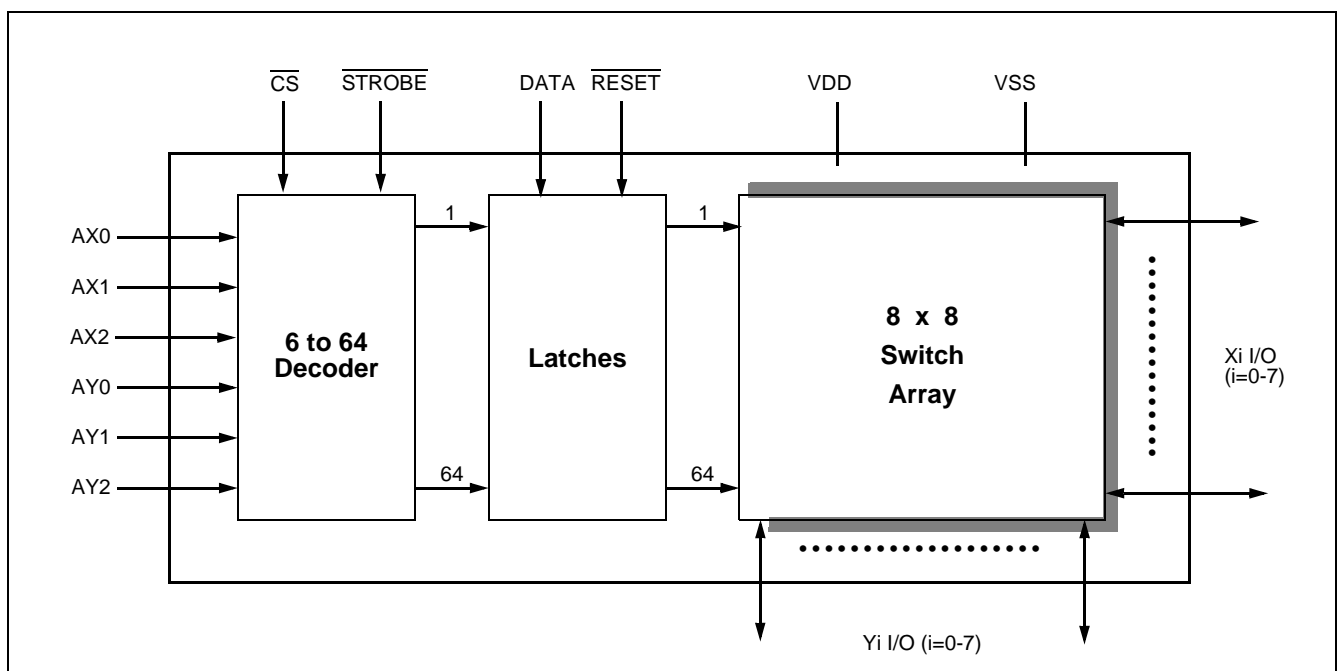


Figure 1 - Functional Block Diagram

Change Summary

Changes from the September 2005 issue to the September 2011 issue.

| Page | Item | Change |
|------|----------------------|--|
| 1 | Ordering Information | Removed leaded packages as per PCN notice. |

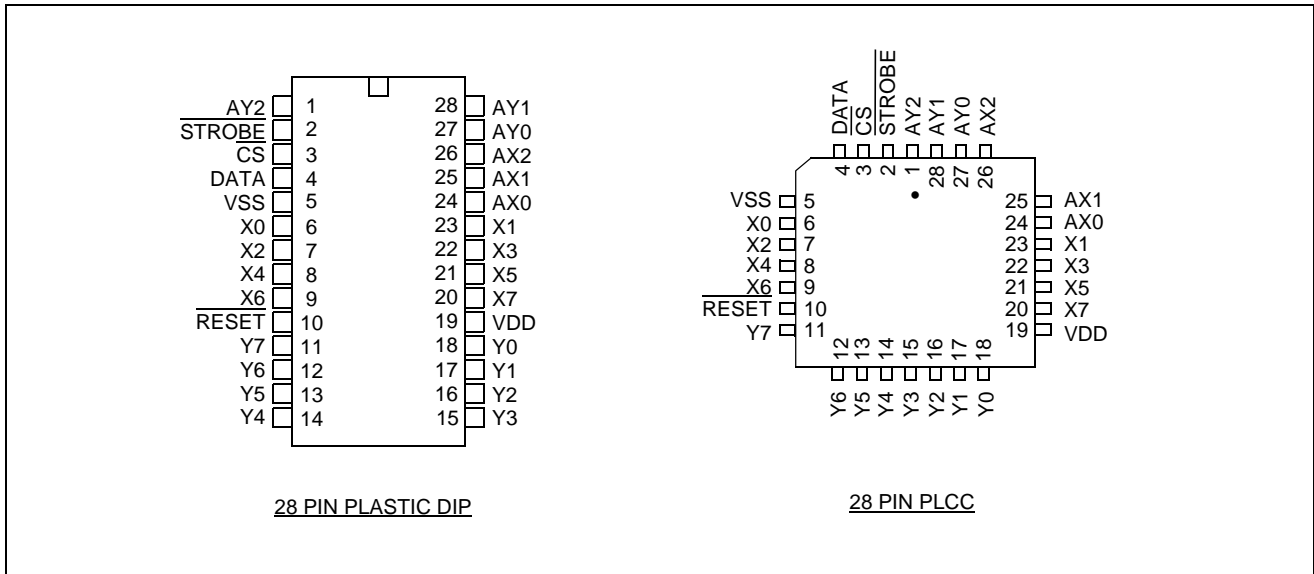


Figure 2 - Pin Connections

Pin Description

| Pin # | Name | Description |
|-------|----------------------------|--|
| 1 | AY2 | AY2 Address Line (Input). |
| 2 | $\overline{\text{STROBE}}$ | STROBE (Input): enables function selected by address and data. Address must be stable before STROBE goes low and DATA must be stable on the rising edge of $\overline{\text{STROBE}}$. Active Low. |
| 3 | $\overline{\text{CS}}$ | Chip Select (Input): this is used to select the device. Active Low. |
| 4 | DATA | DATA (Input): a logic high input will turn on the selected switch and a logic low will turn off the selected switch. Active High. |
| 5 | V _{SS} | Ground Reference. |
| 6-9 | X0, X2, X4, X6 | X0, X2, X4 and X6 Analog (Inputs/Outputs): these are connected to the X0, X2, X4 and X6 rows of the switch array. |
| 10 | $\overline{\text{RESET}}$ | Master RESET (Input): this is used to turn off all switches regardless of the condition of $\overline{\text{CS}}$. A 100 k Ω internal pull-up resistor is also provided. This can be used in conjunction with a 0.1 μF capacitor (connected to the $\overline{\text{RESET}}$ pin) to perform power-on reset of the device. Active Low. |
| 11-18 | Y7 - Y0 | Y7 - Y0 Analog (Inputs/Outputs): these are connected to the Y0 - Y7 columns of the switch array. |

Pin Description

| Pin # | Name | Description |
|--------|-----------------|--|
| 19 | V _{DD} | Positive Power Supply. |
| 20-23 | X7, X5, X3, X1 | X7, X5, X3 and X1 Analog (Inputs/Outputs): these are connected to the X7, X5, X3 and X1 rows of the switch array. |
| 24-26 | AX0-AX2 | AX0 - AX2 Address Lines (Inputs). |
| 27, 28 | AY0, AY1 | AY0 and AY1 Address Lines (Inputs). |

Functional Description

The MT8809 is an analog switch matrix with an array size of 8 x 8. The switch array is arranged such that there are 8 columns by 8 rows. The columns are referred to as the Y inputs/outputs and the rows are the X inputs/outputs. The crosspoint analog switch array will interconnect any X I/O with any Y I/O when turned on and provide a high degree of isolation when turned off. The control memory consists of a 64 bit write only RAM in which the bits are selected by the address inputs (AY0-AY2, AX0-AX2). Data is presented to the memory on the DATA input. Data is asynchronously written into memory whenever both the \overline{CS} (Chip Select) and \overline{STROBE} inputs are low and are latched on the rising edge of \overline{STROBE} . A logical "1" written into a memory cell turns the corresponding crosspoint switch on and a logical "0" turns the crosspoint off. Only the crosspoint switches corresponding to the addressed memory location are altered when data is written into memory. The remaining switches retain their previous states. Any combination of X and Y inputs/outputs can be interconnected by establishing appropriate patterns in the control memory. A logical "0" on the \overline{RESET} input will asynchronously return all memory locations to logical "0" turning off all crosspoint switches regardless of whether \overline{CS} is high or low.

Address Decode

The six address inputs along with the \overline{STROBE} and \overline{CS} (Chip Select) are logically ANDed to form an enable signal for the resettable transparent latches. The DATA input is buffered and is used as the input to all latches. To write to a location, \overline{RESET} must be high and \overline{CS} must go low while the address and data are set up. Then the \overline{STROBE} input is set low and then high causing the data to be latched. The data can be changed while \overline{STROBE} is low, however, the corresponding switch will turn on and off in accordance with the DATA input. DATA must be stable on the rising edge of \overline{STROBE} in order for correct data to be written to the latch.

Absolute Maximum Ratings* - Voltages are with respect to V_{SS} unless otherwise stated.

| | Parameter | Symbol | Min. | Max. | Units |
|---|---------------------------|-----------|--------------|--------------|--------------------|
| 1 | Supply Voltage | V_{DD} | -0.3 | 15.0 | V |
| | | V_{SS} | -0.3 | $V_{DD}+0.3$ | V |
| 2 | Analog Input Voltage | V_{INA} | -0.3 | $V_{DD}+0.3$ | V |
| 3 | Digital Input Voltage | V_{IN} | $V_{SS}-0.3$ | $V_{DD}+0.3$ | V |
| 4 | Current on any I/O Pin | I | | ± 15 | mA |
| 5 | Storage Temperature | T_S | -65 | +150 | $^{\circ}\text{C}$ |
| 6 | Package Power Dissipation | P_D | | 0.6 | W |

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to V_{SS} unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ. | Max. | Units | Test Conditions |
|---|-----------------------|-----------|----------|------|----------|--------------------|-----------------|
| 1 | Operating Temperature | T_O | -40 | 25 | 85 | $^{\circ}\text{C}$ | |
| 2 | Supply Voltage | V_{DD} | 4.5 | | 13.2 | V | |
| 3 | Analog Input Voltage | V_{INA} | V_{SS} | | V_{DD} | V | |
| 4 | Digital Input Voltage | V_{IN} | V_{SS} | | V_{DD} | V | |

DC Electrical Characteristics[†] - Voltages are with respect to $V_{SS} = 0\text{ V}$, $V_{DD} = 12\text{ V}$ unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ. [‡] | Max. | Units | Test Conditions |
|---|--|------------|------|-------------------|-----------|---------------|--|
| 1 | Quiescent Supply Current | I_{DD} | | 1 | 100 | μA | All digital inputs at $V_{IN} = V_{SS}$ V_{DD} except RESET = V_{DD} . |
| | | | | 120 | 400 | μA | All digital inputs at $V_{IN} = V_{SS}$ or V_{DD} except RESET = V_{SS} . |
| | | | | 0.5 | 1.6 | mA | All digital inputs at $V_{IN} = 2.4\text{ V}$, $V_{DD} = 5.0\text{ V}$ |
| | | | | 5 | 15 | mA | All digital inputs at $V_{IN} = 3.4\text{ V}$ |
| 2 | Off-state Leakage Current (See G.9 in Appendix) | I_{OFF} | | ± 1 | ± 500 | nA | $ V_{Xi} - V_{Yj} = V_{DD} - V_{SS}$ See Appendix, Fig. A.1 |
| 3 | Input Logic "0" level | V_{IL} | | | 0.8 | V | |
| 4 | Input Logic "1" level | V_{IH} | 3.0 | | | V | |
| 6 | Input Leakage (digital pins) | I_{LEAK} | | 0.1 | 10 | μA | All digital inputs at $V_{IN} = V_{SS}$ or V_{DD} ; RESET = V_{DD} |

[†] DC Electrical Characteristics are over recommended temperature range.

[‡] Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

DC Electrical Characteristics- Switch Resistance - V_{DC} is the external DC offset applied at the analog I/O pins.

| | Characteristics | Sym. | 25°C | | 70°C | | 85°C | | Units | Test Conditions |
|---|---|-----------------|-----------------|-----------------|------|-----------------|------|-----------------|----------------------------------|---|
| | | | Typ. | Max. | Typ. | Max. | Typ. | Max. | | |
| 1 | On-state Resistance $V_{DD}=12V$ $V_{DD}=10V$ $V_{DD}=5V$ (See G.1, G.2, G.3 in Appendix) | R_{ON} | 45 55 120 | 65 75 185 | | 75 85 215 | | 80 90 225 | Ω Ω Ω | $V_{SS} = 0V, V_{DC} = V_{DD}/2,$ $ V_{Xi}-V_{Yj} = 0.4V$ See Appendix, Fig. A.2 |
| 2 | Difference in on-state resistance between two switches (See G.4 in Appendix) | ΔR_{ON} | 5 | 10 | | 10 | | 10 | Ω | $V_{DD} = 12V, V_{SS} = 0,$ $V_{DC} = V_{DD}/2,$ $ V_{Xi}-V_{Yj} = 0.4V$ See Appendix, Fig. A.2 |

AC Electrical Characteristics[†] - Crosspoint Performance - V_{DC} is the external DC offset at the analog I/O pins. Voltages are with respect to $V_{DD} = 5V, V_{DC} = 0V, V_{SS} = -7V$, unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ. [‡] | Max. | Units | Test Conditions |
|---|---|------------|------|-------------------|------|-------|---|
| 1 | Switch I/O Capacitance | C_S | | 20 | | pF | $f = 1MHz$ |
| 2 | Feedthrough Capacitance | C_F | | 0.2 | | pF | $f = 1MHz$ |
| 3 | Frequency Response Channel "ON" $20\text{LOG}(V_{OUT}/V_{Xi})=-3dB$ | F_{3dB} | | 45 | | MHz | Switch is "ON"; $V_{INA} = 2V_{pp}$ sinewave; $R_L = 1k\Omega$ See Appendix, Fig. A.3 |
| 4 | Total Harmonic Distortion (See G.5, G.6 in Appendix) | THD | | 0.01 | | % | Switch is "ON"; $V_{INA} = 2V_{pp}$ sinewave $f = 1kHz; R_L = 1k\Omega$ |
| 5 | Feedthrough Channel "OFF" Feed.= $20\text{LOG}(V_{OUT}/V_{Xi})$ (See G.8 in Appendix) | FDT | | -95 | | dB | All Switches "OFF"; $V_{INA} = 2V_{pp}$ sinewave $f = 1kHz;$ $R_L = 1k\Omega.$ See Appendix, Fig. A.4 |
| 6 | Crosstalk between any two channels for switches X_i-Y_i and $X_j-Y_j.$ $X_{talk}=20\text{LOG}(V_{Yj}/V_{Xi}).$ (See G.7 in Appendix). | X_{talk} | | -45 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 10MHz; R_L = 75\Omega.$ |
| | | | | -90 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 10kHz; R_L = 600\Omega.$ |
| | | | | -85 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 10kHz; R_L = 1k\Omega.$ |
| | | | | -80 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 1kHz; R_L = 10k\Omega.$ Refer to Appendix, Fig. A.5 for test circuit. |
| 7 | Propagation delay through switch | t_{PS} | | | 30 | ns | $R_L = 1k\Omega; C_L = 50pF$ |

[†] Timing is over recommended temperature range. See Fig. 3 for control and I/O timing details.

[‡] Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

Crosstalk measurements are for Plastic DIPS only, crosstalk values for PLCC packages are approximately 5 dB better.

AC Electrical Characteristics[†] - Control and I/O Timings - V_{DC} is the external DC offset applied at the analog I/O pins. Voltages are with respect to $V_{DD} = 5\text{ V}$, $V_{DC} = 0\text{ V}$, $V_{SS} = -7\text{ V}$, unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ. [‡] | Max. | Units | Test Conditions |
|----|---|-------------|------|-------------------|------|-------|--|
| 1 | Control Input crosstalk to switch (for CS, DATA, STROBE, Address) | CX_{talk} | | 30 | | mVpp | $V_{IN}=3V+V_{DC}$ squarewave; $R_{IN}=1\text{ k}\Omega$, $R_L=1\text{ k}\Omega$. See Appendix, Fig. A.6 |
| 2 | Digital Input Capacitance | C_{DI} | | 10 | | pF | $f = 1\text{ MHz}$ |
| 3 | Switching Frequency | F_O | | | 20 | MHz | |
| 4 | Setup Time DATA to $\overline{\text{STROBE}}$ | t_{DS} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 5 | Hold Time DATA to $\overline{\text{STROBE}}$ | t_{DH} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 6 | Setup Time Address to $\overline{\text{STROBE}}$ | t_{AS} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 7 | Hold Time Address to $\overline{\text{STROBE}}$ | t_{AH} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 8 | Setup Time CS to $\overline{\text{STROBE}}$ | t_{CSS} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 9 | Hold Time CS to $\overline{\text{STROBE}}$ | t_{CSH} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 10 | $\overline{\text{STROBE}}$ Pulse Width | t_{SPW} | 20 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 11 | $\overline{\text{RESET}}$ Pulse Width | t_{RPW} | 40 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 12 | $\overline{\text{STROBE}}$ to Switch Status Delay | t_S | | 40 | 100 | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 13 | DATA to Switch Status Delay | t_D | | 50 | 100 | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 14 | $\overline{\text{RESET}}$ to Switch Status Delay | t_R | | 35 | 100 | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |

[†] Timing is over recommended temperature range. See Fig. 3 for control and I/O timing details. Digital Input rise time (t_r) and fall time (t_f) = 5 ns.

[‡] Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

\hat{A}_i Refer to Appendix, Fig. A.7 for test circuit.

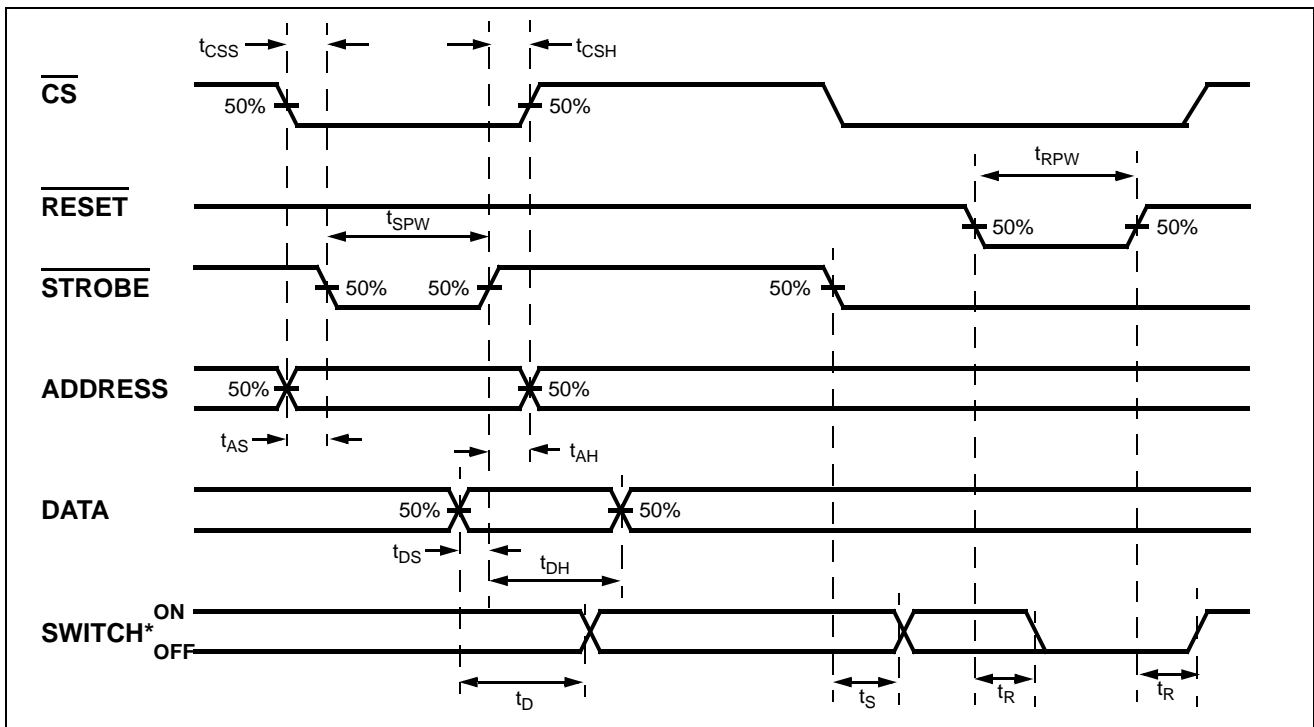


Figure 3 - Control Memory Timing Diagram

* See Appendix, Fig. A.7 for switching waveform

| AY2 | AY1 | AY0 | AX2 | AX1 | AX0 | Connection | AY2 | AY1 | AY0 | AX2 | AX1 | AX0 | Connection |
|-----|-----|-----|-----|-----|-----|------------|-----|-----|-----|-----|-----|-----|------------|
| 0 | 0 | 0 | 0 | 0 | 0 | X0 Y0 | 1 | 0 | 0 | 0 | 0 | 0 | X0 Y4 |
| 0 | 0 | 0 | 0 | 0 | 1 | X1 Y0 | 1 | 0 | 0 | 0 | 0 | 1 | X1 Y4 |
| 0 | 0 | 0 | 0 | 1 | 0 | X2 Y0 | 1 | 0 | 0 | 0 | 1 | 0 | X2 Y4 |
| 0 | 0 | 0 | 0 | 1 | 1 | X3 Y0 | 1 | 0 | 0 | 0 | 1 | 1 | X3 Y4 |
| 0 | 0 | 0 | 1 | 0 | 0 | X4 Y0 | 1 | 0 | 0 | 1 | 0 | 0 | X4 Y4 |
| 0 | 0 | 0 | 1 | 0 | 1 | X5 Y0 | 1 | 0 | 0 | 1 | 0 | 1 | X5 Y4 |
| 0 | 0 | 0 | 1 | 1 | 0 | X6 Y0 | 1 | 0 | 0 | 1 | 1 | 0 | X6 Y4 |
| 0 | 0 | 0 | 1 | 1 | 1 | X7 Y0 | 1 | 0 | 0 | 1 | 1 | 1 | X7 Y4 |
| 0 | 0 | 1 | 0 | 0 | 0 | X0 Y1 | 1 | 0 | 1 | 0 | 0 | 0 | X0 Y5 |
| 0 | 0 | 1 | 0 | 0 | 1 | X1 Y1 | 1 | 0 | 1 | 0 | 0 | 1 | X1 Y5 |
| 0 | 0 | 1 | 0 | 1 | 0 | X2 Y1 | 1 | 0 | 1 | 0 | 1 | 0 | X2 Y5 |
| 0 | 0 | 1 | 0 | 1 | 1 | X3 Y1 | 1 | 0 | 1 | 0 | 1 | 1 | X3 Y5 |
| 0 | 0 | 1 | 1 | 0 | 0 | X4 Y1 | 1 | 0 | 1 | 1 | 0 | 0 | X4 Y5 |
| 0 | 0 | 1 | 1 | 0 | 1 | X5 Y1 | 1 | 0 | 1 | 1 | 0 | 1 | X5 Y5 |
| 0 | 0 | 1 | 1 | 1 | 0 | X6 Y1 | 1 | 0 | 1 | 1 | 1 | 0 | X6 Y5 |
| 0 | 0 | 1 | 1 | 1 | 1 | X7 Y1 | 1 | 0 | 1 | 1 | 1 | 1 | X7 Y5 |
| 0 | 1 | 0 | 0 | 0 | 0 | X0 Y2 | 1 | 1 | 0 | 0 | 0 | 0 | X0 Y6 |
| 0 | 1 | 0 | 0 | 0 | 1 | X1 Y2 | 1 | 1 | 0 | 0 | 0 | 1 | X1 Y6 |
| 0 | 1 | 0 | 0 | 1 | 0 | X2 Y2 | 1 | 1 | 0 | 0 | 1 | 0 | X2 Y6 |
| 0 | 1 | 0 | 0 | 1 | 1 | X3 Y2 | 1 | 1 | 0 | 0 | 1 | 1 | X3 Y6 |
| 0 | 1 | 0 | 1 | 0 | 0 | X4 Y2 | 1 | 1 | 0 | 1 | 0 | 0 | X4 Y6 |
| 0 | 1 | 0 | 1 | 0 | 1 | X5 Y2 | 1 | 1 | 0 | 1 | 0 | 1 | X5 Y6 |
| 0 | 1 | 0 | 1 | 1 | 0 | X6 Y2 | 1 | 1 | 0 | 1 | 1 | 0 | X6 Y6 |
| 0 | 1 | 0 | 1 | 1 | 1 | X7 Y2 | 1 | 1 | 0 | 1 | 1 | 1 | X7 Y6 |
| 0 | 1 | 1 | 0 | 0 | 0 | X0 Y3 | 1 | 1 | 1 | 0 | 0 | 0 | X0 Y7 |
| 0 | 1 | 1 | 0 | 0 | 1 | X1 Y3 | 1 | 1 | 1 | 0 | 0 | 1 | X1 Y7 |
| 0 | 1 | 1 | 0 | 1 | 0 | X2 Y3 | 1 | 1 | 1 | 0 | 1 | 0 | X2 Y7 |
| 0 | 1 | 1 | 0 | 1 | 1 | X3 Y3 | 1 | 1 | 1 | 0 | 1 | 1 | X3 Y7 |
| 0 | 1 | 1 | 1 | 0 | 0 | X4 Y3 | 1 | 1 | 1 | 1 | 0 | 0 | X4 Y7 |
| 0 | 1 | 1 | 1 | 0 | 1 | X5 Y3 | 1 | 1 | 1 | 1 | 0 | 1 | X5 Y7 |
| 0 | 1 | 1 | 1 | 1 | 0 | X6 Y3 | 1 | 1 | 1 | 1 | 1 | 0 | X6 Y7 |
| 0 | 1 | 1 | 1 | 1 | 1 | X7 Y3 | 1 | 1 | 1 | 1 | 1 | 1 | X7 Y7 |

Table 1 - Address Decode Truth Table

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September 2005

- Internal control latches and address decoder
- Short setup and hold times
- Wide operating voltage: 4.5 V to 13.2 V
- 12 V_{pp} analog signal capability
- R_{ON} 65 Ω max. @ V_{DD} = 12 V, 25°C
- ΔR_{ON} ≤ 10 Ω @ V_{DD} = 12 V, 25C
- Full CMOS switch for low distortion
- Minimum feedthrough and crosstalk
- Low power consumption ISO-CMOS technology
- Internal pull-up resistor for $\overline{\text{RESET}}$ pin

Applications

- Key systems
- PBX systems
- Mobile radio
- Test equipment/instrumentation
- Analog/digital multiplexers
- Audio/Video switching

Ordering Information

| | | |
|------------|--------------|-------------|
| MT8809AE | 28 Pin PDIP | Tubes |
| MT8809AP | 28 Pin PLCC | Tubes |
| MT8809APR | 28 Pin PLCC | Tape & Reel |
| MT8809AP1 | 28 Pin PLCC* | Tubes |
| MT8809APR1 | 28 Pin PLCC* | Tape & Reel |
| MT8809AE1 | 28 Pin PDIP* | Tubes |

* Pb Free Matte Tin

-40°C to +85°C

Description

The Zarlink MT8809 is fabricated in Zarlink's ISO-CMOS technology providing low power dissipation and high reliability. The device contains a 8 x 8 array of crosspoint switches along with a 6 to 64 line decoder and latch circuits. Any one of the 64 switches can be addressed by selecting the appropriate six address bits. The selected switch can be turned on or off by applying a logical one or zero to the DATA input. Chip Select (CS) allows the crosspoint array to be cascaded for matrix expansion.

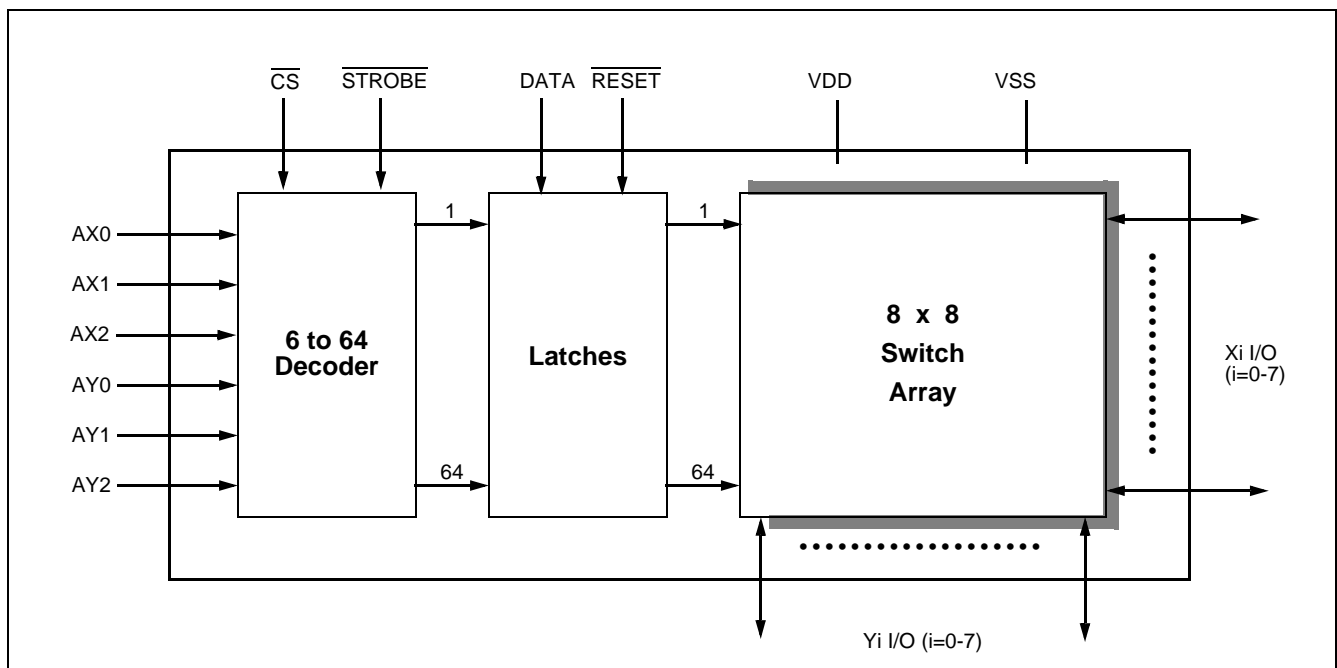


Figure 1 - Functional Block Diagram

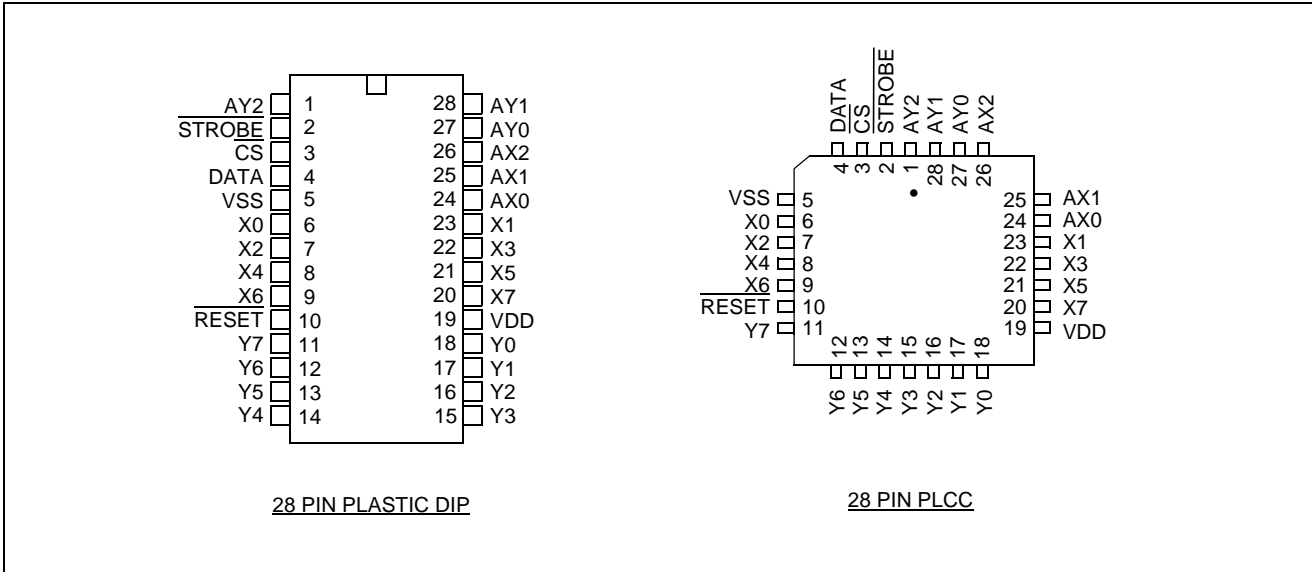


Figure 2 - Pin Connections

Pin Description

| Pin # | Name | Description |
|--------|----------------------------|--|
| 1 | AY2 | AY2 Address Line (Input). |
| 2 | $\overline{\text{STROBE}}$ | STROBE (Input): enables function selected by address and data. Address must be stable before $\overline{\text{STROBE}}$ goes low and DATA must be stable on the rising edge of $\overline{\text{STROBE}}$. Active Low. |
| 3 | $\overline{\text{CS}}$ | Chip Select (Input): this is used to select the device. Active Low. |
| 4 | DATA | DATA (Input): a logic high input will turn on the selected switch and a logic low will turn off the selected switch. Active High. |
| 5 | V _{SS} | Ground Reference. |
| 6-9 | X0, X2, X4, X6 | X0, X2, X4 and X6 Analog (Inputs/Outputs): these are connected to the X0, X2, X4 and X6 rows of the switch array. |
| 10 | $\overline{\text{RESET}}$ | Master RESET (Input): this is used to turn off all switches regardless of the condition of CS. A 100 kΩ internal pull-up resistor is also provided. This can be used in conjunction with a 0.1 μF capacitor (connected to the RESET pin) to perform power-on reset of the device. Active Low. |
| 11-18 | Y7 - Y0 | Y7 - Y0 Analog (Inputs/Outputs): these are connected to the Y0 - Y7 columns of the switch array. |
| 19 | V _{DD} | Positive Power Supply. |
| 20-23 | X7, X5, X3, X1 | X7, X5, X3 and X1 Analog (Inputs/Outputs): these are connected to the X7, X5, X3 and X1 rows of the switch array. |
| 24-26 | AX0-AX2 | AX0 - AX2 Address Lines (Inputs). |
| 27, 28 | AY0, AY1 | AY0 and AY1 Address Lines (Inputs). |

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The MT8809 is an analog switch matrix with an array size of 8 x 8. The switch array is arranged such that there are 8 columns by 8 rows. The columns are referred to as the Y inputs/outputs and the rows are the X inputs/outputs. The crosspoint analog switch array will interconnect any X I/O with any Y I/O when turned on and provide a high degree of isolation when turned off. The control memory consists of a 64 bit write only RAM in which the bits are selected by the address inputs (AY0-AY2, AX0-AX2). Data is presented to the memory on the DATA input. Data is asynchronously written into memory whenever both the CS (Chip Select) and STROBE inputs are low and are latched on the rising edge of STROBE. A logical "1" written into a memory cell turns the corresponding crosspoint switch on and a logical "0" turns the crosspoint off. Only the crosspoint switches corresponding to the addressed memory location are altered when data is written into memory. The remaining switches retain their previous states. Any combination of X and Y inputs/outputs can be interconnected by establishing appropriate patterns in the control memory. A logical "0" on the RESET input will asynchronously return all memory locations to logical "0" turning off all crosspoint switches regardless of whether CS is high or low.

Address Decode

The six address inputs along with the $\overline{\text{STROBE}}$ and $\overline{\text{CS}}$ (Chip Select) are logically ANDed to form an enable signal for the resettable transparent latches. The DATA input is buffered and is used as the input to all latches. To write to a location, $\overline{\text{RESET}}$ must be high and $\overline{\text{CS}}$ must go low while the address and data are set up. Then the $\overline{\text{STROBE}}$ input is set low and then high causing the data to be latched. The data can be changed while $\overline{\text{STROBE}}$ is low, however, the corresponding switch will turn on and off in accordance with the DATA input. DATA must be stable on the rising edge of $\overline{\text{STROBE}}$ in order for correct data to be written to the latch.

Absolute Maximum Ratings* - Voltages are with respect to V_{SS} unless otherwise stated.

| | Parameter | Symbol | Min. | Max. | Units |
|---|---------------------------------------|-----------|--------------|--------------|--------------------|
| 1 | Supply Voltage | V_{DD} | -0.3 | 15.0 | V |
| | | V_{SS} | -0.3 | $V_{DD}+0.3$ | V |
| 2 | Analog Input Voltage | V_{INA} | -0.3 | $V_{DD}+0.3$ | V |
| 3 | Digital Input Voltage | V_{IN} | $V_{SS}-0.3$ | $V_{DD}+0.3$ | V |
| 4 | Current on any I/O Pin | I | | ± 15 | mA |
| 5 | Storage Temperature | T_S | -65 | +150 | $^{\circ}\text{C}$ |
| 6 | Package Power Dissipation PLASTIC DIP | P_D | | 0.6 | W |

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to V_{SS} unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ. | Max. | Units | Test Conditions |
|---|-----------------------|-----------|----------|------|----------|--------------------|-----------------|
| 1 | Operating Temperature | T_O | -40 | 25 | 85 | $^{\circ}\text{C}$ | |
| 2 | Supply Voltage | V_{DD} | 4.5 | | 13.2 | V | |
| 3 | Analog Input Voltage | V_{INA} | V_{SS} | | V_{DD} | V | |
| 4 | Digital Input Voltage | V_{IN} | V_{SS} | | V_{DD} | V | |

DC Electrical Characteristics[†] - Voltages are with respect to $V_{SS} = 0\text{ V}$, $V_{DD} = 12\text{ V}$ unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ. [‡] | Max. | Units | Test Conditions |
|---|--|------------|------|-------------------|-----------|---------------|--|
| 1 | Quiescent Supply Current | I_{DD} | | 1 | 100 | μA | All digital inputs at $V_{IN} = V_{SS}$ V_{DD} except RESET = V_{DD} . |
| | | | | 120 | 400 | μA | All digital inputs at $V_{IN} = V_{SS}$ or V_{DD} except RESET = V_{SS} . |
| | | | | 0.5 | 1.6 | mA | All digital inputs at $V_{IN} = 2.4\text{ V}$, $V_{DD} = 5.0\text{ V}$ |
| | | | | 5 | 15 | mA | All digital inputs at $V_{IN} = 3.4\text{ V}$ |
| 2 | Off-state Leakage Current (See G.9 in Appendix) | I_{OFF} | | ± 1 | ± 500 | nA | $ V_{XI} - V_{Yj} = V_{DD} - V_{SS}$ See Appendix, Fig. A.1 |
| 3 | Input Logic "0" level | V_{IL} | | | 0.8 | V | |
| 4 | Input Logic "1" level | V_{IH} | 3.0 | | | V | |
| 6 | Input Leakage (digital pins) | I_{LEAK} | | 0.1 | 10 | μA | All digital inputs at $V_{IN} = V_{SS}$ or V_{DD} ; RESET = V_{DD} |

[†] DC Electrical Characteristics are over recommended temperature range.

[‡] Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

DC Electrical Characteristics- Switch Resistance - V_{DC} is the external DC offset applied at the analog I/O pins.

| | Characteristics | Sym. | 25°C | | 70°C | | 85°C | | Units | Test Conditions |
|---|--|-----------------|------|------|------|------|------|------|----------|---|
| | | | Typ. | Max. | Typ. | Max. | Typ. | Max. | | |
| 1 | On-state $V_{DD}=12V$ Resistance $V_{DD}=10V$ $V_{DD}=5V$ (See G.1, G.2, G.3 in Appendix) | R_{ON} | 45 | 65 | | 75 | | 80 | Ω | $V_{SS} = 0V, V_{DC} = V_{DD}/2,$ $ V_{Xi}-V_{Yj} = 0.4V$ See Appendix, Fig. A.2 |
| | | | 55 | 75 | | 85 | | 90 | Ω | |
| | | | 120 | 185 | | 215 | | 225 | Ω | |
| 2 | Difference in on-state resistance between two switches (See G.4 in Appendix) | ΔR_{ON} | 5 | 10 | | 10 | | 10 | Ω | $V_{DD} = 12V, V_{SS} = 0,$ $V_{DC} = V_{DD}/2,$ $ V_{Xi}-V_{Yj} = 0.4V$ See Appendix, Fig. A.2 |

AC Electrical Characteristics† - Crosspoint Performance - V_{DC} is the external DC offset at the analog I/O pins. Voltages are with respect to $V_{DD} = 5V, V_{DC} = 0V, V_{SS} = -7V$, unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ.‡ | Max. | Units | Test Conditions |
|---|---|------------|------|-------|------|-------|--|
| 1 | Switch I/O Capacitance | C_S | | 20 | | pF | $f = 1MHz$ |
| 2 | Feedthrough Capacitance | C_F | | 0.2 | | pF | $f = 1MHz$ |
| 3 | Frequency Response Channel "ON" $20\text{LOG}(V_{OUT}/V_{Xi})=-3dB$ | F_{3dB} | | 45 | | MHz | Switch is "ON"; $V_{INA} = 2V_{pp}$ sinewave; $R_L = 1k\Omega$ See Appendix, Fig. A.3 |
| 4 | Total Harmonic Distortion (See G.5, G.6 in Appendix) | THD | | 0.01 | | % | Switch is "ON"; $V_{INA} = 2V_{pp}$ sinewave $f = 1kHz$; $R_L = 1k\Omega$ |
| 5 | Feedthrough Channel "OFF" Feed.= $20\text{LOG}(V_{OUT}/V_{Xi})$ (See G.8 in Appendix) | FDT | | -95 | | dB | All Switches "OFF"; $V_{INA} = 2V_{pp}$ sinewave $f = 1kHz$; $R_L = 1k\Omega$. See Appendix, Fig. A.4 |
| 6 | Crosstalk between any two channels for switches X_i-Y_i and X_j-Y_j . $X_{talk}=20\text{LOG}(V_{Yj}/V_{Xi})$. (See G.7 in Appendix). | X_{talk} | | -45 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 10MHz$; $R_L = 75\Omega$ |
| | | | | -90 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 10kHz$; $R_L = 600\Omega$. |
| | | | | -85 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 10kHz$; $R_L = 1k\Omega$. |
| | | | | -80 | | dB | $V_{INA} = 2V_{pp}$ sinewave $f = 1kHz$; $R_L = 10k\Omega$. Refer to Appendix, Fig. A.5 for test circuit. |
| 7 | Propagation delay through switch | t_{PS} | | | 30 | ns | $R_L = 1k\Omega; C_L = 50pF$ |

† Timing is over recommended temperature range. See Fig. 3 for control and I/O timing details.

‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

Crosstalk measurements are for Plastic DIPS only, crosstalk values for PLCC packages are approximately 5 dB better.

AC Electrical Characteristics† - Control and I/O Timings- V_{DC} is the external DC offset applied at the analog I/O pins. Voltages are with respect to $V_{DD} = 5\text{ V}$, $V_{DC} = 0\text{ V}$, $V_{SS} = -7\text{ V}$, unless otherwise stated.

| | Characteristics | Sym. | Min. | Typ.‡ | Max. | Units | Test Conditions |
|----|---|-------------|------|-------|------|-------|--|
| 1 | Control Input crosstalk to switch (for CS, DATA, STROBE, Address) | CX_{talk} | | 30 | | mVpp | $V_{IN}=3V+V_{DC}$ squarewave; $R_{IN}=1\text{ k}\Omega$, $R_L=1\text{ k}\Omega$. See Appendix, Fig. A.6 |
| 2 | Digital Input Capacitance | C_{DI} | | 10 | | pF | $f = 1\text{ MHz}$ |
| 3 | Switching Frequency | F_O | | | 20 | MHz | |
| 4 | Setup Time DATA to $\overline{\text{STROBE}}$ | t_{DS} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 5 | Hold Time DATA to $\overline{\text{STROBE}}$ | t_{DH} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 6 | Setup Time Address to $\overline{\text{STROBE}}$ | t_{AS} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 7 | Hold Time Address to $\overline{\text{STROBE}}$ | t_{AH} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 8 | Setup Time CS to $\overline{\text{STROBE}}$ | t_{CSS} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 9 | Hold Time CS to $\overline{\text{STROBE}}$ | t_{CSH} | 10 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 10 | $\overline{\text{STROBE}}$ Pulse Width | t_{SPW} | 20 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 11 | RESET Pulse Width | t_{RPW} | 40 | | | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 12 | $\overline{\text{STROBE}}$ to Switch Status Delay | t_S | | 40 | 100 | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 13 | DATA to Switch Status Delay | t_D | | 50 | 100 | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |
| 14 | RESET to Switch Status Delay | t_R | | 35 | 100 | ns | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ \hat{A}_i |

† Timing is over recommended temperature range. See Fig. 3 for control and I/O timing details. Digital Input rise time (t_r) and fall time (t_f) = 5 ns.

‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

\hat{A}_i Refer to Appendix, Fig. A.7 for test circuit.

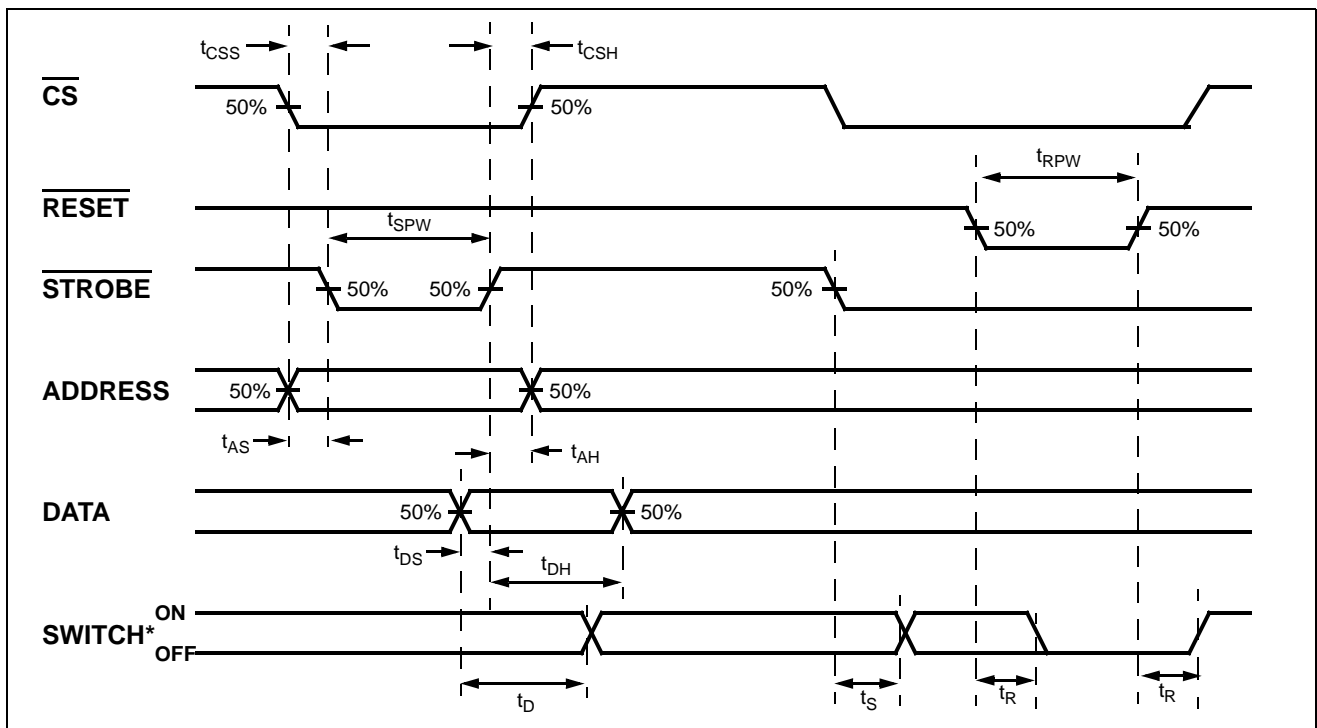
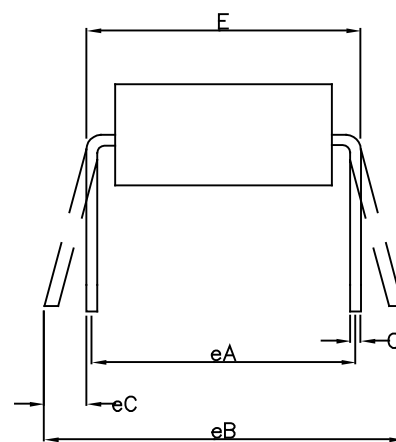
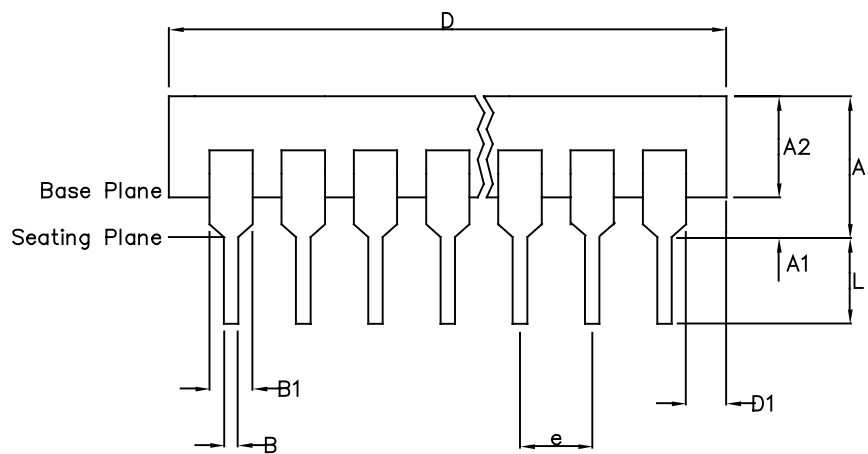
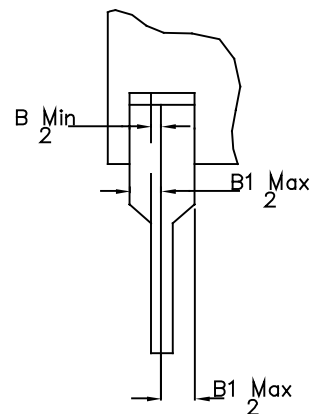
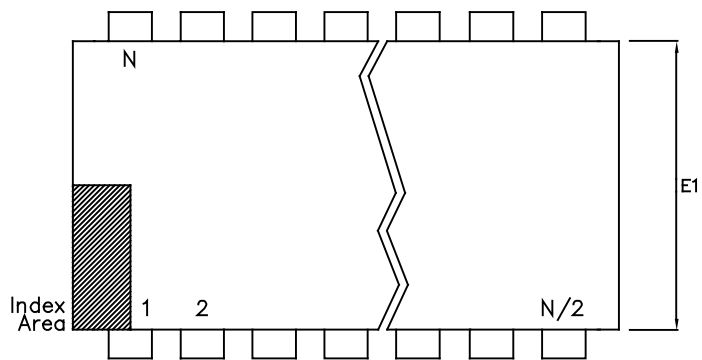


Figure 3 - Control Memory Timing Diagram

* See Appendix, Fig. A.7 for switching waveform

| AY2 | AY1 | AY0 | AX2 | AX1 | AX0 | Connection | AY2 | AY1 | AY0 | AX2 | AX1 | AX0 | Connection |
|-----|-----|-----|-----|-----|-----|------------|-----|-----|-----|-----|-----|-----|------------|
| 0 | 0 | 0 | 0 | 0 | 0 | X0 Y0 | 1 | 0 | 0 | 0 | 0 | 0 | X0 Y4 |
| 0 | 0 | 0 | 0 | 0 | 1 | X1 Y0 | 1 | 0 | 0 | 0 | 0 | 1 | X1 Y4 |
| 0 | 0 | 0 | 0 | 1 | 0 | X2 Y0 | 1 | 0 | 0 | 0 | 1 | 0 | X2 Y4 |
| 0 | 0 | 0 | 0 | 1 | 1 | X3 Y0 | 1 | 0 | 0 | 0 | 1 | 1 | X3 Y4 |
| 0 | 0 | 0 | 1 | 0 | 0 | X4 Y0 | 1 | 0 | 0 | 1 | 0 | 0 | X4 Y4 |
| 0 | 0 | 0 | 1 | 0 | 1 | X5 Y0 | 1 | 0 | 0 | 1 | 0 | 1 | X5 Y4 |
| 0 | 0 | 0 | 1 | 1 | 0 | X6 Y0 | 1 | 0 | 0 | 1 | 1 | 0 | X6 Y4 |
| 0 | 0 | 0 | 1 | 1 | 1 | X7 Y0 | 1 | 0 | 0 | 1 | 1 | 1 | X7 Y4 |
| 0 | 0 | 1 | 0 | 0 | 0 | X0 Y1 | 1 | 0 | 1 | 0 | 0 | 0 | X0 Y5 |
| 0 | 0 | 1 | 0 | 0 | 1 | X1 Y1 | 1 | 0 | 1 | 0 | 0 | 1 | X1 Y5 |
| 0 | 0 | 1 | 0 | 1 | 0 | X2 Y1 | 1 | 0 | 1 | 0 | 1 | 0 | X2 Y5 |
| 0 | 0 | 1 | 0 | 1 | 1 | X3 Y1 | 1 | 0 | 1 | 0 | 1 | 1 | X3 Y5 |
| 0 | 0 | 1 | 1 | 0 | 0 | X4 Y1 | 1 | 0 | 1 | 1 | 0 | 0 | X4 Y5 |
| 0 | 0 | 1 | 1 | 0 | 1 | X5 Y1 | 1 | 0 | 1 | 1 | 0 | 1 | X5 Y5 |
| 0 | 0 | 1 | 1 | 1 | 0 | X6 Y1 | 1 | 0 | 1 | 1 | 1 | 0 | X6 Y5 |
| 0 | 0 | 1 | 1 | 1 | 1 | X7 Y1 | 1 | 0 | 1 | 1 | 1 | 1 | X7 Y5 |
| 0 | 1 | 0 | 0 | 0 | 0 | X0 Y2 | 1 | 1 | 0 | 0 | 0 | 0 | X0 Y6 |
| 0 | 1 | 0 | 0 | 0 | 1 | X1 Y2 | 1 | 1 | 0 | 0 | 0 | 1 | X1 Y6 |
| 0 | 1 | 0 | 0 | 1 | 0 | X2 Y2 | 1 | 1 | 0 | 0 | 1 | 0 | X2 Y6 |
| 0 | 1 | 0 | 0 | 1 | 1 | X3 Y2 | 1 | 1 | 0 | 0 | 1 | 1 | X3 Y6 |
| 0 | 1 | 0 | 1 | 0 | 0 | X4 Y2 | 1 | 1 | 0 | 1 | 0 | 0 | X4 Y6 |
| 0 | 1 | 0 | 1 | 0 | 1 | X5 Y2 | 1 | 1 | 0 | 1 | 0 | 1 | X5 Y6 |
| 0 | 1 | 0 | 1 | 1 | 0 | X6 Y2 | 1 | 1 | 0 | 1 | 1 | 0 | X6 Y6 |
| 0 | 1 | 0 | 1 | 1 | 1 | X7 Y2 | 1 | 1 | 0 | 1 | 1 | 1 | X7 Y6 |
| 0 | 1 | 1 | 0 | 0 | 0 | X0 Y3 | 1 | 1 | 1 | 0 | 0 | 0 | X0 Y7 |
| 0 | 1 | 1 | 0 | 0 | 1 | X1 Y3 | 1 | 1 | 1 | 0 | 0 | 1 | X1 Y7 |
| 0 | 1 | 1 | 0 | 1 | 0 | X2 Y3 | 1 | 1 | 1 | 0 | 1 | 0 | X2 Y7 |
| 0 | 1 | 1 | 0 | 1 | 1 | X3 Y3 | 1 | 1 | 1 | 0 | 1 | 1 | X3 Y7 |
| 0 | 1 | 1 | 1 | 0 | 0 | X4 Y3 | 1 | 1 | 1 | 1 | 0 | 0 | X4 Y7 |
| 0 | 1 | 1 | 1 | 0 | 1 | X5 Y3 | 1 | 1 | 1 | 1 | 0 | 1 | X5 Y7 |
| 0 | 1 | 1 | 1 | 1 | 0 | X6 Y3 | 1 | 1 | 1 | 1 | 1 | 0 | X6 Y7 |
| 0 | 1 | 1 | 1 | 1 | 1 | X7 Y3 | 1 | 1 | 1 | 1 | 1 | 1 | X7 Y7 |

Table 1 - Address Decode Truth Table



| | Min mm | Max mm | Min Inches | Max Inches |
|----------------------------------|-----------|--------|------------|------------|
| A | | 6.35 | | 0.250 |
| A1 | 0.38 | | 0.015 | |
| A2 | 3.18 | 4.95 | 0.125 | 0.195 |
| B | 0.36 | 0.56 | 0.014 | 0.022 |
| B1 | 0.76 | 1.78 | 0.030 | 0.070 |
| C | 0.20 | 0.38 | 0.008 | 0.015 |
| D | 35.05 | 39.75 | 1.380 | 1.565 |
| D1 | 0.13 | | 0.005 | |
| E | 15.24 | 15.88 | 0.600 | 0.625 |
| E1 | 12.32 | 14.73 | 0.485 | 0.580 |
| e | 2.54 BSC | | 0.100 BSC | |
| eA | 15.24 BSC | | 0.600 BSC | |
| eB | | 17.78 | | 0.700 |
| L | 2.92 | 5.08 | 0.115 | 0.200 |
| N | 28 | | 28 | |
| Conforms to Jeduc MS-011AB ISS.B | | | | |

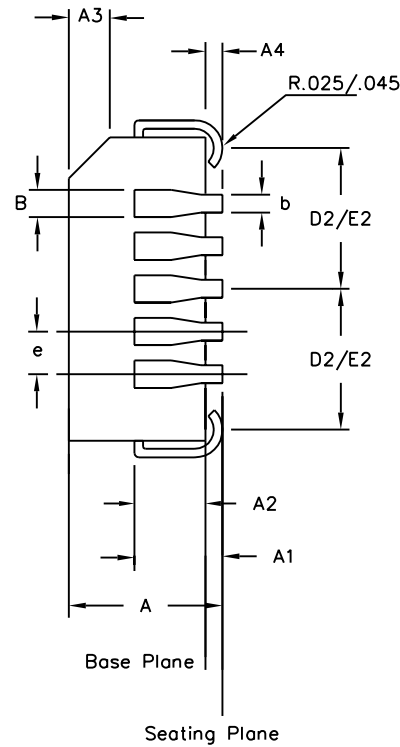
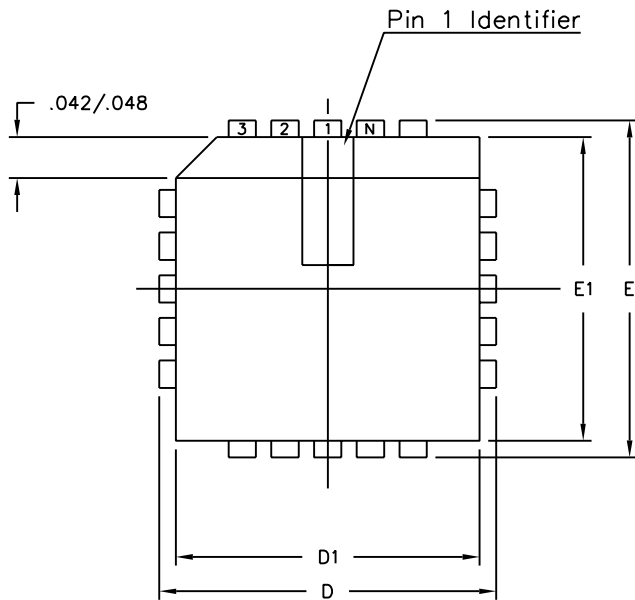
- Notes:
1. Controlling Dimensions are in inches
 2. Dimension A, A1 and L are measured with the package seated in the Seating Plane
 3. Dimensions D & E1 do not include mould flash or protrusions. Mould flash or protrusion shall not exceed 0.010 inch.
 4. Dimensions E & eA are measured with leads constrained to be perpendicular to plane T.
 5. Dimensions eB & eC are measured at the lead tips with the leads unconstrained; eC must be zero or greater.

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| ISSUE | 1 | 2 | 3 | 4 |
|--------|---------|---------|---------|---------|
| ACN | 7010 | 203532 | 213102 | CDCA |
| DATE | 20Apr95 | 25Nov97 | 15Jul02 | 02Dec05 |
| APPRD. | | | | |



| | |
|------------------------|---|
| Package Code | DA |
| Previous package codes | DP / E |
| | Package Outline for 28 lead 600mils PDIP |
| | GPD00072 |



| Symbol | Control Dimensions in inches | | Altern. Dimensions in millimetres | |
|-----------------------------------|---------------------------------|-------|--------------------------------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.165 | 0.180 | 4.19 | 4.57 |
| A1 | 0.090 | 0.120 | 2.29 | 3.05 |
| A2 | 0.062 | 0.083 | 1.57 | 2.11 |
| A3 | 0.042 | 0.056 | 1.07 | 1.42 |
| A4 | 0.020 | — | 0.51 | — |
| D | 0.485 | 0.495 | 12.32 | 12.57 |
| D1 | 0.450 | 0.456 | 11.43 | 11.58 |
| D2 | 0.191 | 0.219 | 4.85 | 5.56 |
| E | 0.485 | 0.495 | 12.32 | 12.57 |
| E1 | 0.450 | 0.456 | 11.43 | 11.58 |
| E2 | 0.191 | 0.219 | 4.85 | 5.56 |
| B | 0.026 | 0.032 | 0.66 | 0.81 |
| b | 0.013 | 0.021 | 0.33 | 0.53 |
| e | 0.050 | BSC | 1.27 | BSC |
| Pin features | | | | |
| ND | 7 | | | |
| NE | 7 | | | |
| N | 28 | | | |
| Note | Square | | | |
| Conforms to JEDEC MS-018AB Iss. A | | | | |

Notes:

1. All dimensions and tolerances conform to ANSI Y14.5M-1982
2. Dimensions D1 and E1 do not include mould protrusions.
Allowable mould protrusion is 0.010" per side. Dimensions D1 and E1 include mould protrusion mismatch and are determined at the parting line, that is D1 and E1 are measured at the extreme material condition at the upper or lower parting line.
3. Controlling dimensions in Inches.
4. "N" is the number of terminals.
5. Not To Scale
6. Dimension R required for 120° minimum bend.

| | | | | |
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| ACN | 5958 | 207469 | 212422 | |
| DATE | 15Aug94 | 10Sep99 | 22Mar02 | |
| APPRD. | | | | |



| | |
|------------------------|--------|
| Previous package codes | HP / P |
|------------------------|--------|

| | |
|-------------------------------------|----|
| Package Code | QA |
| Package Outline for 28 lead PLCC | |
| GPD00002 | |



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